

C0805X432FATACTU

Aliases (C0805X432FATAC7800) SMD Comm X8G HT150C Flex, Ceramic, 4,300 pF, 1%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0805, 0.6 mm



Click here for the 3D model.

General Information		
Series	SMD Comm X8G HT150C Flex	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	No	
AEC-Q200	No	
Typical Component Weight	13 mg	
Shelf Life	78 Weeks	
MSL	1	

4,300 pF

250 VDC

625 VDC -55/+150°C

30 ppm/C, 1kHz 1.0Vrms

0% Loss/Decade Hour: Referee

0.1% 1 kHz 1.0Vrms

Time is 1000 Hours

100 GOhms

X8G

1%

1 kHz 1.0Vrms

Dimensions		Specifications	
Chip Size	0805	Capacitance	
L	2mm +/-0.3mm	Measurement Condition	
W	1.25mm +/-0.3mm	Tolerance	
т	0.9mm +/-0.10mm	Voltage DC	
S	0.6mm MIN	Dielectric Withstanding Voltage	
В	0.5mm +/-0.25mm	Temperature Range	
		Temp. Coefficient	
Packaging Specifications		Capacitance Change with	
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC	

1.25mm +/-0.3mm	Tolerance	
0.9mm +/-0.10mm	Voltage DC	
0.6mm MIN	Dielectric Withstanding Vo	
0.5mm +/-0.25mm	Temperature Range	
	Temp. Coefficient	
	Capacitance Change with	
T&R, 180mm, Plastic Tape	Reference to +25°C and 0 \ Applied (TCC)	
4000	Dissipation Factor	

Aging Rate

Insulation Resistance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Packaging Quantity